MMS1V50-WM-SKY

Mellanox® Compatible 400GBase-FR4 QSFP-DD Transceiver (SMF, 1310nm, 2km, LC, DOM)

Product Description

This Mellanox® compatible QSFP-DD transceiver provides 400GBase-FR4 throughput up to 2km over single-mode fiber (SMF) using a wavelength of 1310nm via an LC connector. It can operate at temperatures between 0 and 70C. Our transceiver is built to meet or exceed OEM specifications and is guaranteed to be 100% compatible with Mellanox®. It has been programmed, uniquely serialized, and tested for data-traffic and application to ensure that it will initialize and perform identically. All of our transceivers comply with Multi-Source Agreement (MSA) standards to provide seamless network integration. Additional product features include Digital Optical Monitoring (DOM) support which allows access to real-time operating parameters. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

Skylane's transceivers are RoHS compliant and lead-free.

Features:

- INF-8628 Compliance
- Duplex LC Connector
- Commercial Temperature 0 to 70 Celsius
- Single-mode Fiber
- Hot Pluggable
- Excellent ESD Protection
- Metal with Lower EMI
- RoHS Compliant and Lead Free

Applications:

- 400GBase Ethernet
- Access and Enterprise

For your product safety, please read the following information carefully before any manipulation of the transceiver:

ESD

This transceiver is specified as ESD threshold 1kV for SFI pins and 2kV for all others electrical input pins, tested per MIL-STD-883G, Method 3015.4 /JESD22-A114-A (HBM). However, normal ESD precautions are still required during the handling of this module.

LASER SAFETY

This is a Class1 Laser Product according to IEC 60825-1:2007. This product complies with 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No. 50, dated (June 24, 2007).

The optical ports of the module need to be terminated with an optical connector or with a dust plug in order to avoid contamination.

Regulatory Compliance

- ESD to the Electrical PINs: compatible with MIL-STD-883E Method 3015.4
- ESD to the LC Receptacle: compatible with IEC 61000-4-3
- EMI/EMC compatible with FCC Part 15 Subpart B Rules, EN55022:2010
- Laser Eye Safety compatible with FDA 21CFR, EN60950-1& EN (IEC) 60825-1,2
- RoHS compliant with EU RoHS 2.0 directive 2015/863/EU

Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit
Power Supply Voltage	Vcc	-0.5	3.6	V
Storage Temperature	Tstg	-40	85	°C
Operating Case Temperature	Tc	0	70	°C
Relative Humidity (non-condensing)	RH	0	85	%

Recommended Operating Conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Operating Case Temperature	T_C	0		70	°C	
Power Supply Voltage	V_{CC}	3.135	3.3	3.465	V	
Data Rate Per Lane			26.5625		GBd	PAM4
Data Rate Accuracy		-100		100	ppm	
Pre-FEC Bit Error Ratio				$2.4x10^{-4}$		
Post-FEC Bit Error Ratio				$1x10^{-12}$		1
Link Distance	D	0.5		2000	m	2

Notes:

1. FEC provided by host system.
2. FEC required on host system to support maximum distance.

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Power Consumption				12	W	
Supply Current	Icc			3.64	A	
Transmitter (each lane)						
Signaling Rate Per Lane	TP1	26.5625 ± 100 ppm			GBd	
Differential pk-pk Input Voltage Tolerance	TP1a	900			mVp-p	1
Differential Termination Mismatch	TP1			10	%	
Differential Input Return Loss	TP1	IEEE 802.3-2015 Equation (83E-5)			dB	
Differential to Common-Mode Input Return Loss	TP1	IEEE 802.3-2015 Equation (83E-6)			dB	
Module Stressed Input Test	TP1a	See IEEE 802.3bs 120E.3.4.1				2
Single-Ended Voltage Tolerance Range (Minimum)	TP1a	-0.4 to 3.3			V	
DC Common-Mode Input Voltage	TP1	-350		2850	mV	3
Receiver (each lane)						
Signaling Rate, each lane	TP4	26.5625 ± 100 ppm			GBd	
Differential Peak-to-Peak Output Voltage	TP4			900	mVp-p	
AC Common Mode Output Voltage, RMS	TP4			17.5	mV	
Differential Termination Mismatch	TP4			10	%	
Differential Output Return Loss	TP4	IEEE 802.3-2015 Equation (83E-2)				
Common to Differential Mode Conversion Return Loss	TP4	IEEE 802.3-2015 Equation (83E-3)				
Transition Time, 20% to 80%	TP4	9.5			ps	
Near-end Eye Symmetry Mask Width (ESMW)	TP4		0.265		UI	
Near-end Eye Height, Differential	TP4	70			mV	
Far-end Eye Symmetry Mask Width (ESMW)	TP4		0.2		UI	
Far-end Eye Height, Differential	TP4	30			mV	
Far-end Pre-cursor ISI Ratio	TP4	-4.5		2.5	%	
Common Mode Output Voltage (Vcm)	TP4	-350		2850	mV	3

Notes:

1. With the exception to IEEE 802.3bs 120E.3.1.2 that the pattern is PRBS31Q or scrambled idle.
2. Meets BER specified in IEEE 802.3bs 120E.1.1.
3. DC common-mode voltage is generated by the host. Specification includes effects of ground offset voltage.

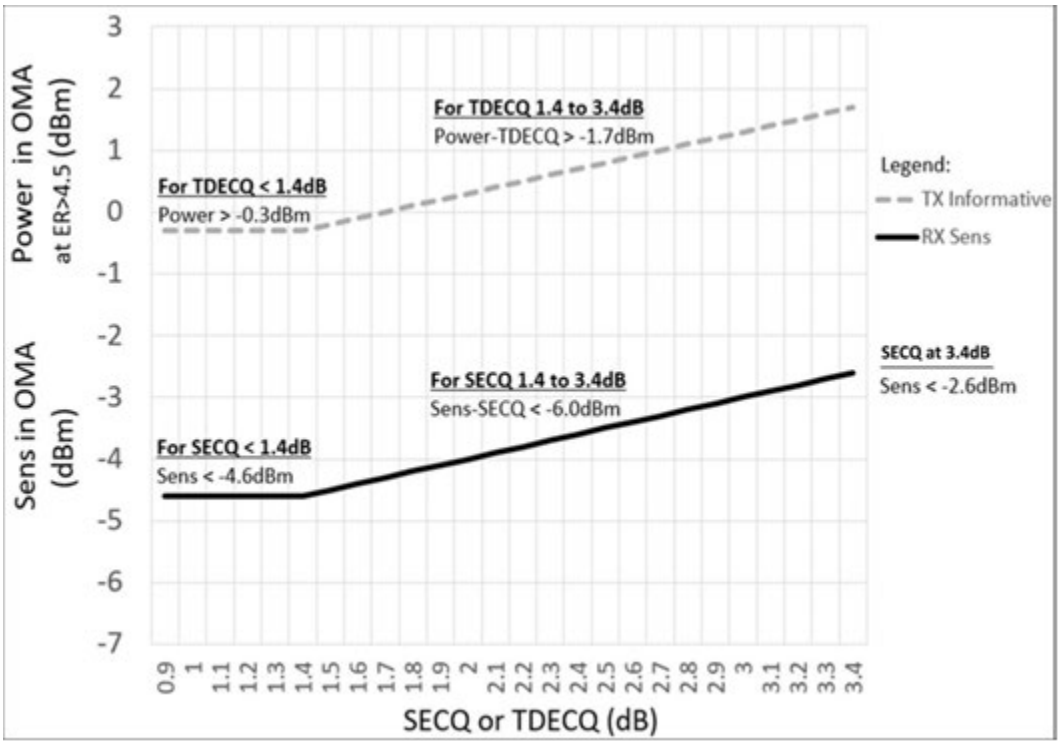
Optical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Lane Wavelength	L0	1264.5	1271	1277.5	nm	
	L1	1284.5	1291	1297.5		
	L2	1304.5	1311	1317.5		
	L3	1324.5	1331	1337.5		
Transmitter						
Data Rate Per Lane		53.125 ± 100 ppm			GBd	
Modulation Format		PAM4				
Side-Mode Suppression Ratio	SMSR	30			dB	Modulated
Total Average Launch Power	P_T			9.3	dBm	
Average Launch Power Per Lane	Pavg	-3.3		3.5	dBm	1
Outer Optical Modulation Amplitude (OMA_{outer}) Per Lane	POMA	-0.3		3.7	dBm	2
Launch Power in OMA_{outer} minus TDECQ Per Lane		-1.7			dB	For ER ≥4.5dB
Launch Power in OMA_{outer} minus TDECQ Per Lane		-1.6			dB	For ER <4.5dB
Transmitter and Dispersion Eye Closer for PAM4 Per Lane	TDECQ			3.4	dB	
Extinction Ratio	ER	3.5			dB	
Difference in Launch Power Between Any Two Lanes (OMA_{outer})				4	dB	
$RIN_{17.1}$ OMA	RIN			-136	dB/Hz	
Optical Return Loss Tolerance	TOL			17.1	dB	
Transmitter Reflectance				-26	dB	
Average Launch Power of OFF Transmitter Per Lane	Poff			-20	dBm	
Receiver						
Data Rate Per Lane		53.125 ± 100 ppm			GBd	
Modulation Format		PAM4				
Damage Threshold Per Lane	THd	4.5			dBm	3
Average Receive Power Per Lane		-7.3		3.5	dBm	4
Receive Power (OMA_{outer}) Per Lane				3.7	dBm	
Difference in Receiver Power Between Any Two Lanes (OMA_{outer})				4.1	dB	
Receiver Sensitivity (OMA_{outer}) Per Lane	S			-5.0	dBm	For BER of $2.4E^{-4}$
Stressed Receiver Sensitivity (OMA_{outer}) Per Lane	SRS	See Figure Below			dBm	5
Receiver Reflectance				-26	dB	
LOS Assert	LOSA	-30			dBm	
LOS De-assert	LOSD			-12	dBm	
LOS Hysteresis	LOSH	0.5			dB	

Stressed Conditions for Stress Receiver Sensitivity (Note 6)						
Stressed Eye Closure for PAM4 (SECQ) Lane under Test		0.9		3.4	dB	
OMA_{outer} of Each Aggressor Lane			1.5		dBm	

Notes:

1. Average launch power, each lane (minimum), is informative and not the principal indicator of signal strength. A transmitter with launch power below this value cannot be compliant; however, a value above this does not ensure compliance.
2. Even if the TDECQ<1.4 dB for an extinction ratio of ≥4.5dB or TDECQ<1.3dB for an extinction ratio of <4.5 dB, the OMA_{outer} (minimum) must exceed the minimum value specified here.
3. The receiver shall be able to tolerate, without damage, continuous exposure to an optical input signal having this average power level.
4. Average receive power, each lane (minimum) is informative and not the principal indicator of signal strength. A received power below this value cannot be compliant; however, a value above this does not ensure compliance.
5. Measured with conformance test signal for BER = 2.4×10^{-4}. A compliant receiver shall have stressed receiver sensitivity (OMA_{outer}), each lane values below the mask of the figure below, for SECQ values between 0.9 and 3.4 dB.
6. These test conditions are for measuring stressed receiver sensitivity. They are not characteristics of the receiver.

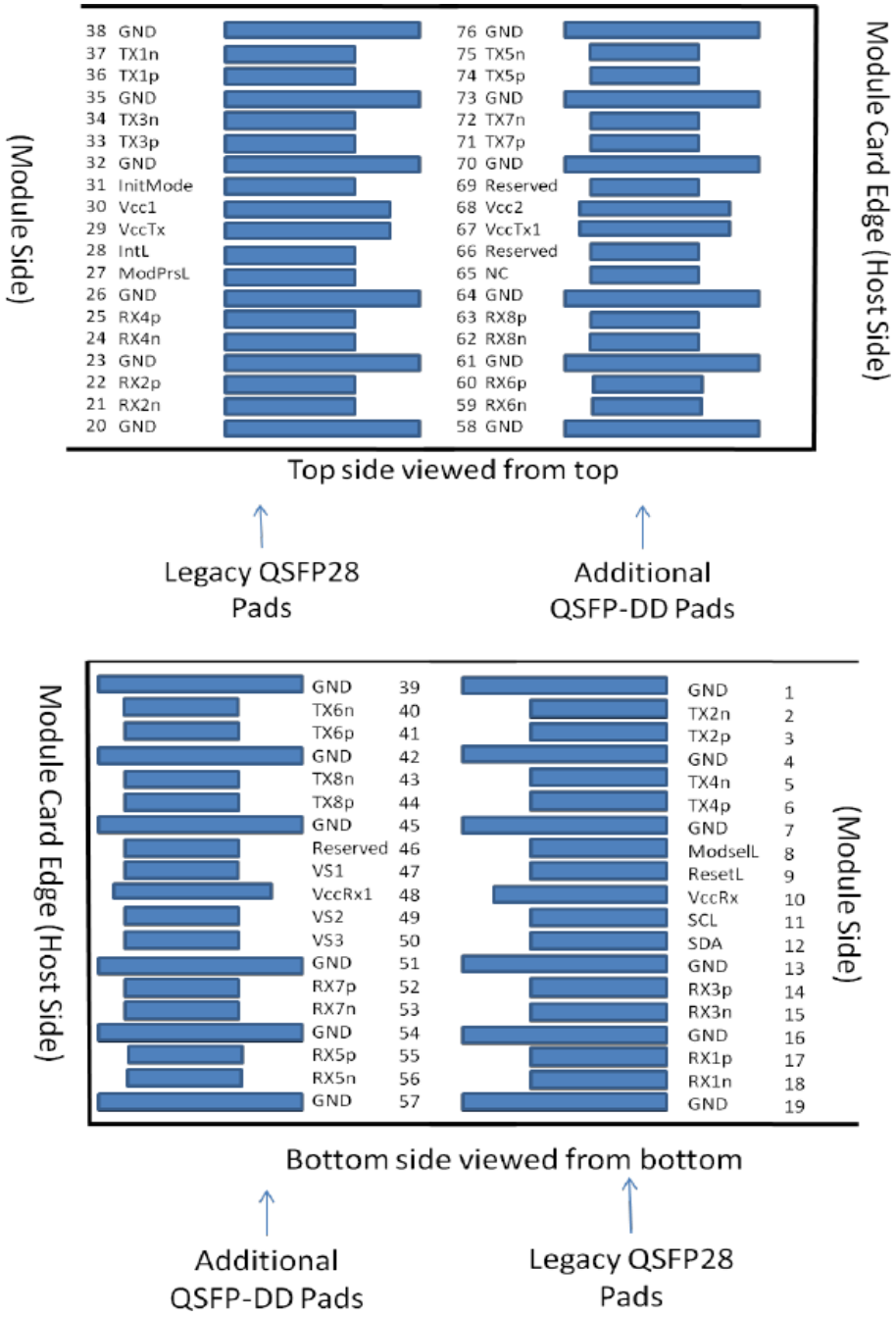


Pin Descriptions

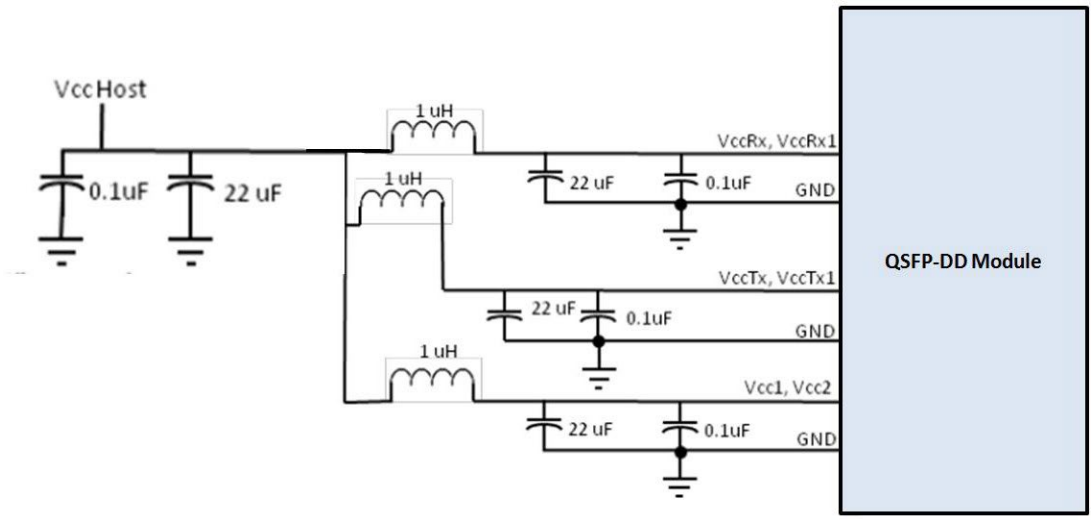
Pin	Logic	Symbol	Name/Descriptions	Plug Sequence
1		GND	Module Ground.	1B
2	CML-I	Tx2-	Transmitter Inverted Data Input.	3B
3	CML-I	Tx2+	Transmitter Non-Inverted Data Input.	3B
4		GND	Module Ground.	1B
5	CML-I	Tx4-	Transmitter Inverted Data Input.	3B
6	CML-I	Tx4+	Transmitter Non-Inverted Data Input.	3B
7		GND	Module Ground.	1B
8	LVTTL-I	ModSelL	Module Select.	3B
9	LVTTL-I	ResetL	Module Reset.	3B
10		VccRx	+3.3V Power Supply Receiver.	2B
11	LVCMOS-I/O	SCL	2-Wire Serial Interface Clock.	3B
12	LVCMOS-I/O	SDA	2-Wire Serial Interface Data.	3B
13		GND	Module Ground.	1B
14	CML-O	Rx3+	Receiver Non-Inverted Data Output.	3B
15	CML-O	Rx3-	Receiver Inverted Data Output.	3B
16	GND	Ground	Module Ground.	
17	CML-O	Rx1+	Receiver Non-Inverted Data Output.	3B
18	CML-O	Rx1-	Receiver Inverted Data Output.	3B
19		GND	Module Ground.	1B
20		GND	Module Ground.	1B
21	CML-O	Rx2-	Receiver Inverted Data Output.	3B
22	CML-O	Rx2+	Receiver Non-Inverted Data Output.	3B
23		GND	Module Ground.	1B
24	CML-O	Rx4-	Receiver Inverted Data Output.	3B
25	CML-O	Rx4+	Receiver Non-Inverted Data Output.	3B
26		GND	Module Ground.	1B
27	LVTTL-O	ModPrsL	Module Present.	3B
28	LVTTL-O	IntL	Interrupt.	3B
29		VccTx	+3.3V Power supply transmitter.	2B
30		Vcc1	+3.3V Power supply.	2B
31	LVTTL-I	InitMode	Initialization Mode. In legacy QSFP applications, the InitMode pad is called LPMODE.	3B
32		GND	Module Ground.	1B
33	CML-I	Tx3+	Transmitter Non-Inverted Data Input.	3B
34	CML-I	Tx3-	Transmitter Inverted Data Input.	3B
35		GND	Module Ground.	1B
36	CML-I	Tx1+	Transmitter Non-Inverted Data Input.	3B
37	CML-I	Tx1-	Transmitter Inverted Data Input.	3B
38		GND	Module Ground.	1B
39		GND	Module Ground.	1A
40	CML-I	Tx6-	Transmitter Inverted Data Input.	3A

41	CML-I	Tx6+	Transmitter Non-Inverted Data Input.	3A
42		GND	Module Ground.	1A
43	CML-I	Tx8-	Transmitter Inverted Data Input.	3A
44	CML-I	Tx8+	Transmitter Non-Inverted Data Input.	3A
45		GND	Module Ground.	1A
46		Reserved	For Future Use.	3A
47		VS1	Module Vendor-Specific 1.	3A
48		VccRx1	+3.3V Power Supply.	2A
49		VS2	Module Vendor-Specific 2.	3A
50		VS3	Module Vendor-Specific 3.	3A
51		GND	Module Ground.	1A
52	CML-O	Rx7+	Receiver Non-Inverted Data Output.	3A
53	CML-O	Rx7-	Receiver Inverted Data Output.	3A
54		GNZ	Module Ground.	1A
55	CML-O	Rx5+	Receiver Non-Inverted Data Output.	3A
56	CML-O	Rx5-	Receiver Inverted Data Output.	3A
57		GND	Module Ground.	1A
58		GND	Module Ground.	1A
59	CML-O	Rx6-	Receiver Inverted Data Output.	3A
60	CML-O	Rx6+	Receiver Non-Inverted Data Output.	3A
61		GND	Module Ground.	1A
62	CML-O	Rx8-	Receiver Inverted Data Output.	3A
63	CML-O	Rx8+	Receiver Non-Inverted Data Output.	3A
67		GND	Module Ground.	1A
68		NC	No Connect.	3A
69		Reserved	For Future Use.	3A
70		VccTx1	+3.3V Power Supply.	2A
71		Vcc2	+3.3V Power Supply.	2A
72		Reserved	For Future Use.	3A
73		GND	Module Ground.	1A
74	CML-I	Tx7+	Transmitter Non-Inverted Data Input.	3A
75	CML-I	Tx7-	Transmitter Inverted Data Input.	3A
76		GND	Module Ground.	1A

MSA Compliant Connector



Recommended Power Supply Filter



Digital Diagnostic Functions

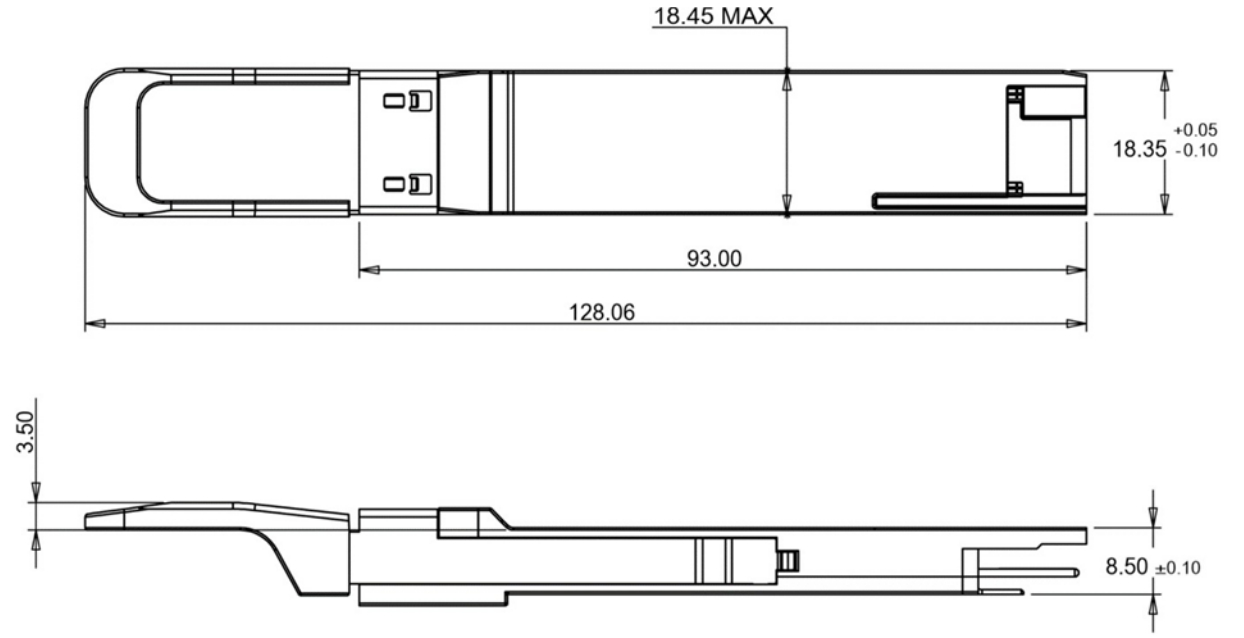
The following digital diagnostic characteristics are defined over the normal operating conditions unless otherwise specified.

Parameter	Symbol	Min	Max	Units	Notes
Temperature Monitor Absolute Error	DMI_Temp	-3	3	degC	Over Operating Temperature Range
Supply Voltage Monitor Absolute Error	DMI _VCC	-0.1	0.1	V	Over Full Operating Range
Channel Rx Power Monitor Absolute Error	DMI_RX_Ch	-2	2	dB	1
Channel Bias Current Monitor	DMI_Ibias_Ch	-10%	10%	mA	
Channel Tx Power Monitor Absolute Error	DMI_TX_Ch	-2	2	dB	1

Notes:

1. Due to measurement accuracy of different single-mode fibers, there could be an additional +/-1 dB fluctuation, or a +/- 3 dB total accuracy.

Mechanical Specifications



About Skylane Optics

Skylane is a leading provider of transceivers for optical communication.

We offer an extensive portfolio for the enterprise, access, datacenter and metropolitan fiber optical market as well as for smart home applications and home networks.

We cover the European, South American and North American market with a strong partner network and have offices in Belgium, Brazil, Sweden and USA.

Our offerings are characterized by high quality and performance. In combination with our strong technical support, we enable our customers to build cost optimized network solutions.

We offer an extensive range of high-quality products including transceivers (Optical and copper), Active Optical Cable (AOC), Direct Attach Cable (DAC), Mux/Demux, Coding Box.